	<u></u>	SPEC No	DG996040
Jun / 16 / 99	SHADD	ISSUE	Iun/16/99
TUNA		PAGE	10 pages
АРРКОVED BY: DATE: Jun / 16/99	ELECTRONIC COMPONENTS GROUP SHARP CORPORATION	REPRESENTA	ATIVE DIVISION:
F. Fukuse	SPECIFICATION	Opto-Electro	nic Devices Division
DEVICE S MODEL N	SPECIFICATION FOR Light Emitting Diode No. GL5ZV44		
1. These specification sheets include Please do not reproduce or cause	de materials protected under the copyright of Si e anyone to reproduce them without Sharp's cor	harp Corporation ("Sharp").
in these specification sheets, as y for any damage resulting from u and the instructions included in (Precautions) (1) This products is design * OA equipment * Telecommunication * Tooling machines If the use of the product (2) or (3), please be su (2) Appropriate measures, the safety design of the and safety when this prise safety in function and p * Transportation com * Traffic signals * Other safety equipmed	well as the precautions mentioned below. Sharp se of the product which does not comply with the these specification sheets, and the precautions re- med for use in the following application areas; * Audio visual equipment * Home appliance on equipment (Terminal) * Measuring equipme * Computers ct in the above application areas is for equipme re to observe the precautions given in those res , such as fail-safe design and redundant design of e overall system and equipment, should be taken roduct is used for equipment which demands his precision, such as ; atrol and safety equipment (aircraft, train, auton & Gas leakage sensor breakers * Rescue and s ment	assumes no response he absolute maximinentioned below. The neutronal below.	nsibility um ratings phs s. ity
(3) Please do not use this p and safety in function a * Space equipment * Nuclear power con	product for equipment which require extremely and precision, such as ; * Telecommunication equipment (for trunk li htrol equipment * Medical equipment	high reliability nes)	
(4) Please contact and con regarding interpretation	sult with a Sharp sales representative if there as n of the above three paragraphs.	e any questions	
3. Please contact and consult with a	a Sharp sales representative for any questions a	bout this product.	
CUSTOMER'S APPROVAL	DATE: PRESEN M.Katoh Departme	Tun TED BY: <u>M</u> .	- 1/8, 1999 hatch yer of
BY:	Engineer Opto-Ele Electroni SHARP (ing Dept.,III ctronic Devices Di c Components Gro CORPORATION	ivision pup

	DG996040	Jun/16/
	MODEL No.	PAGE
	GL5ZV44	1/10
ARP		
<u>GL5ZV44 Specific</u>	ation	
1. Application		
This specification applies to the light emitting diode device Mo	aei No. GL52 V44.	
[AlGainP (dicing or scribe/brake type) Amber LED device		
	D. C. J. H. Westerleichen Des	. 2
2. Outline dimensions and pin connections	Refer to the attached sheet Page	e 2.
		. .
3. Ratings and characteristics	•••••• Refer to the attached sheet Page	e 3∼4.
3-1. Absolute maximum ratings		
3-2. Electro-optical characteristics		
3-3. Detailing Curve		
5-4. Characteristics Diagram		
4. Reliability ·····	····· Refer to the attached sheet Page	e 5.
4-1. Test items and test conditions	-	
4-2. Measurement items and Failure judgement criteria		
5. Incoming inspection ••••••	·····Refer to the attached sheet Page	e 6.
5-1. Applied standard		
5-2. Sampling method and level		
5-3. Test items, judgement criteria and classifica of defect		
5-4. Test items the surface is be applied for flat type, judgemen	it criteria and classifica of defect	
6 Supplement		e 7~8.
6-1. Packing	-	
6-2. Luminous intensity rank		
6-3. Dominant wavelength rank		
6-4. Environment		
7. Precautions for use	····· Refer to the attached sheet Pag	e 9~10.
7-1. Lead forming method		
7-2. Notice of installation		
7-3. Soldering Conditions		



Unit	Material	Finish	Drawing No.
	Lead : (Fe) Cold rolled steel		
<u></u>	Package : Epoxy resin	Lead : Sn plated or wave soldering	51106021

DG996040	Jun/16/99
MODEL No.	PAGE
GL5ZV44	3/10

3. Ratings and characteristics

3-1. Absolute	maximum ratin	gs			(1	[a=25°C)
Parameter		Symbol		Value		Unit
Power dissipation	1	Р		130		mW
Continuous forwa	ard current	I _F		50		mA
Peak forward cur	rent(Note 1)	I _{FM}		100		mA
Derating factor	DC	-		0.67		mA/C
	Pulse	-		1.33		mA/C
Reverse voltage		V _R		5		V
Operating temper	rature	Topr	-40	~	85	°C
Storage temperati	ıre	Tstg	-40	~	100	°C
Soldering temper	ature(Note 2)	Tsol	260 (w	rithin 5 se	conds)	°C

(Note 1) Duty ratio=1/10,Pulse width=0.1ms

(Note 2) At the position of 1.6mm from the bottom resin package

3-2. Electro-optical character	istics				(Ta=25°C)
Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Forward voltage	V _F		-	2.1	2.6	V
Luminous intensity (Note 3)	Iv		795	3100	—	mcd
Peak emission wavelength	λp	IF=20mA	—	591	—	nm
Dominant wavelength	λd		_	588	_	nm
Spectrum radiation bandwidth	$\bigtriangleup \lambda$		-	15	_	nm
Reverse current	I _R	VR=4V	-		100	μΑ
Terminal capacitance	Ct	V=0V,f=1MHz	-	60		pF
Viewing Angle	2 0 1/2	IF=20mA	-	15	-	deg.

(Note 3) Refer to the suplement item 6. regarding the standard of rank classification.

3-3. Derating Curve

Peak Forward Current Derating Curve









4. Reliability

The reliability of products shall be satisfied with items listed below.

4-1. Test items and test c	onditions	Conridence le	evel: 90%
Test items	Test conditions	Samples (n) Defective (C)	LTPD (%)
Solderability	$230\pm5^{\circ}$ C, 5s Prior disposition : Dip in rosin flux	n=11, C=0	20
Soldering temperature	260±5°C, 5s	n=11, C=0	20
Mechanical shock	15 000m/s ² , 0.5ms, 3times / ±X,±Y,±Z direction	n=11, C=0	20
Variable frequency vibration	200m/s^2 , 100 to 2 000 to 100Hz/sweep for 4min. ,4times/ \pm X, \pm Y, \pm Z direction	n=11, C=0	20
Terminal strength (Tension)	Weight:10N, 5s/each terminal	n=11, C=0	20
Terminal strength (Bending)	Weight:5N, $0^{\circ} \rightarrow 90^{\circ} \rightarrow 0^{\circ} \rightarrow -90^{\circ} \rightarrow 0^{\circ}$ / each terminal	n=11, C=0	20
Temperature cycling	-40°C(30min)~+100°C(30min),30 cycles	n=22, C=0	10
High temp. and high humidity storage	Ta=+60°C, 90%RH, t=1000h	n=22, C=0	10
High temperature storage	Ta=100°C, t=1000h	n=22, C=0	10
Low temperature storage	Ta=-40°C, t=1000h	n=22, C=0	10
Operation life	Ta=25°C, I _F MAX, t=1000h *3	n=22, C=0	10

4-1. Test items and test conditions

4-2. Measurement items and Failure judgement criteria *1

Measurement	Symbol	Failure judgement criteria *2
Forward voltage	V _F	V _F > U.S.L. × 1.2
Reverse current	I _R	$I_{R} > U.S.L. \times 2.0$
Luminous intensity	Iv	Iv > The first stage value \times 2.0 or The first stage value \times 0.5 > Iv

X Solderability : Solder shall be adhere at the area of 95% or more of dipped portion.

X Terminal strength : Package is not destroyed, and terminal is not slack.

*1: Measuring condition is in accordance with specification.

*2: U.S.L. is shown by Upper Specification Limit.

*3: I_F MAX.is shown by forward current of absolute maximum ratings.

DG996040	Jun/16/99
MODEL No.	PAGE
GL5ZV44	6/10

5. Incoming inspection

5-1. Applied standard : ISO 2859-1

5-2. Sampling method and level : A single sampling plan, normal inspection level II

: AQL Major defect : 0.065%

Minor defect : 0.4%

5-3. Test items, judgement criteria and classifica of defect

No.	Test items	judgement criteria	classifica of defect
1	Disconnection	Not emit light	
2	Position of Cutting off rim	Different from dimension	Major defect
3	Reverse terminal	Different from dimension	
4	Outline dimensions	Not satisfy outline specification	
5	Characteristics	Over the limit value of specification at V_F , I_R , and I_V	
6	Cut off the rim	Exceed -0.2mm	
7	Foreign substance	White point : Exceed ϕ 0.3mm (on top view)Black point : Exceed ϕ 0.3mm (on top view)String form : Exceed 3.0mm (on top view)	
8	Scratch	Exceed $\phi 0.3$ mm or 0.1 mm × 1.0mm (on top view)	Minor defect
9	Void	Exceed ϕ 0.3mm (on top view)	
10	Uneven density of material for scattering	Extremely uneven density	
11	Unbalanced center	Exceed ±0.25mm from package center	
12	Вип	Exceed +0.2mm againstprovided dimension	
13	Insertion position of terminal	Insertion position of terminal	

5-4. Test items the surface is be applied for flat type, judgement criteria and classifica of defect

No.	Test items	judgement criteria	classifica of defect
14	Chapped the surface	The surface chapped is striking for see the lamp top	Minor defect
15	Hollow the surface	The surface hollow is striking for see the lamp top	

						DG996040	Jun/10/
					MODEL No).	PAGE
						GL5ZV44	7/10
ARP							
Supplement							
6-1. Packing							
6-1-1. Inner pa	ickage						
Put 250	pcs the same l	luminous	intensity ran	k products in	to pack and pu	it following label by p	ack.
Product	weight: 0.28	sg (One P	TOQUCE, I yp.))			
CHIDICATION IAD	T TARIF	٦					
PART No	GL 57V44	- Mode	Inumber				
QUANTITY	250	← Ouan	tity of produ	cts	*		
LOT No. KAS	99B19	← Lot n	umber *		$\overline{\mathbb{O}}$	(2) (3) (4)	(5)
	□-□←	Lumir	nous intensity	v rank	Ŭ	0 0 0	Ŭ
SHA	R P	- domin	ant wavelen	gth rank			
MADE IN	N JAPAN	← Produ	iction countr	y			
	1	-		4111 · N			
() Froduction			ateu arpinate	(ically)			
(2) Support co	xde						
Ô Van af an	advation (tha 1	ant true for	muran of the	voor)			
S rear or pro	oduction(the is	ast two ng	guies of the	year)			
(4) Month of r	1 .1	4. 6. 5		habetically u	rith January co	rresponding to A)	
	broduction		indicated alp				
	production	(10 DE 1	ndicated aip	nationally w		incoponding to ray	
(5) Date of pro	oduction(01~	(to be 1 ·31)	ndicated aip	naoctically w		aresponding to ry	
(5) Date of pro	oduction(01~	(10 be 1 •31)	indicated alp.			arcsponding to ray	
5 Date of pro6-1-2. Outer pa	oduction oduction(01~ ackage	(10 be 1 •31)	indicated alp			intesponding to ray	
 5 Date of pro 6-1-2. Outer pa Put 8 pa 	production oduction(01~ ackage acks (the same	(10 be 1 ·31) e luminou	s intensity ra	unk) into oute	er package.	intesponding to ray	
 Date of pro 6-1-2. Outer pa Put 8 par 	production oduction(01~ ackage acks (the same	(10 be 1 ·31) e luminou	s intensity ra	unk) into oute	er package.	insponding to rsy	
 5 Date of pro 6-1-2. Outer pa Put 8 pa (approxi 	production oduction(01~ ackage acks (the same imately 670g p	(10 be 1 ·31) e luminou per one ou	ndicated aip s intensity ra uter package	unk) into oute	er package.		
 5 Date of pro 6-1-2. Outer pa Put 8 pa (approxi 6.1.3 Outer pa 	production oduction(01~ ackage acks (the same imately 670g p ackage out line	(to be 1 ·31) e luminou per one ou	s intensity ra uter package	ank) into oute	er package.	insponding to <i>T</i> sy	
 5 Date of pro 6-1-2. Outer pa Put 8 pa: (approxi 6-1-3. Outer pa 	production oduction(01~ ackage acks (the same imately 670g p ackage out line	(to be 1 ·31) e luminou: per one ou e dimensio	s intensity ra uter package	ank) into oute	er package.	intesponding to Tx)	
 5 Date of pro 6-1-2. Outer pa Put 8 pa (approxi 6-1-3. Outer pa Width : 	production oduction(01~ ackage acks (the same imately 670g p ackage out line 140mm, Dep	(to be 1 ·31) e luminou per one ou e dimensio oth : 225n	n dicated aip s intensity ra uter package on nm, Hight :	unk) into oute) 90mm	er package.	intesponding to <i>T</i> x)	
 (5) Date of pro 6-1-2. Outer pa Put 8 pa (approxi 6-1-3. Outer pa Width : 	production oduction(01~ ackage acks (the same imately 670g p ackage out line 140mm, Dep	(to be 1 ·31) e luminou per one ou e dimensio oth : 225n	s intensity ra uter package on nm, Hight :	ank) into oute) 90mm	(Tran 25%)	insponding to <i>T</i> sy	
 5 Date of pro 6-1-2. Outer pa Put 8 pa (approxi 6-1-3. Outer pa Width : 6-2.Luminous i 	production oduction(01~ ackage acks (the same imately 670g p ackage out line 140mm, Dep intensity rank	(to be 1 ·31) e luminou per one ou e dimensio oth : 225n (Note 1)	s intensity ra uter package on nm, Hight :	ank) into oute) 90mm	Ta=25°C)	intosponding (o 7x)	
 5 Date of pro 6-1-2. Outer pa Put 8 pa (approxi 6-1-3. Outer pa Width : 6-2.Luminous i Rank 	production oduction(01~ ackage acks (the same imately 670g p ackage out line 140mm, Dep intensity rank	(to be f 31) e luminou per one ou e dimensio oth : 225n (Note 1) inous inte	s intensity ra uter package on nm, Hight :	nnk) into oute) 90mm Unit	(Ta=25°C) Condition	intosponding (o 7x)	
 (5) Date of pro 6-1-2. Outer pa Put 8 pa (approxi 6-1-3. Outer pa Width : 6-2.Luminous i Rank M 	production oduction(01~ ackage acks (the same imately 670g p ackage out line 140mm, Dep intensity rank 	(to be 1 ·31) e luminour per one or e dimension oth : 225r (Note 1) inous inte	s intensity ra uter package on nm, Hight : nsity 1548_	nnk) into oute) 90mm <u>Unit</u>	$(Ta=25^{\circ}C)$		
 5 Date of pro 6-1-2. Outer pa Put 8 pa (approxi 6-1-3. Outer pa Width : 6-2.Luminous i Rank M N 	production oduction(01~ ackage imately 670g p ackage out line 140mm, Dep intensity rank Lum 795 1144	(to be 1 ·31) e luminou per one ou e dimensio oth : 225n (Note 1) inous inte ~	s intensity ra uter package on nm, Hight : <u>nsity</u> <u>1548</u> 2229	90mm Unit mcd	(Ta=25°C) Condition I_F =20mA	intosponomig (o 7x)	
 5 Date of pro 6-1-2. Outer pa Put 8 pa (approxi 6-1-3. Outer pa Width : 6-2.Luminous i Rank M N O 	production oduction(01~ ackage acks (the same imately 670g p ackage out line 140mm, Dep intensity rank 795 1144 1648	(to be 1 ·31) e luminou per one ou e dimensio oth : 225r (Note 1) inous inte ~ ~ ~	s intensity ra uter package on nm, Hight : <u>insity</u> 1548 2229 3210 (1623)	90mm Unit mcd	(Ta=25°C) Condition I_F =20mA	intosponomig (o 7x)	
 S Date of pro 6-1-2. Outer pa Put 8 pa (approxi 6-1-3. Outer pa Width : 6-2.Luminous i Rank M O P 	production oduction(01~ ackage acks (the same imately 670g p ackage out line 140mm, Dep intensity rank Lumi 795 1144 1648 2373	(to be 1 \cdot 31) e luminou per one of e dimensio oth : 225n (Note 1) inous inte ~ ~ ~	s intensity ra uter package on nm, Hight : 1548 2229 3210 (4623)	90mm Unit mcd	(Ta=25°C) Condition I_{F} =20mA		
 (5) Date of pro 6-1-2. Outer pa Put 8 pa (approxi 6-1-3. Outer pa Width : 6-2.Luminous i 6-2.Luminous i Rank M O P (Note 1) Tolera 	production oduction(01~ ackage acks (the same imately 670g p ackage out line 140mm, Dep intensity rank 140mm, Dep intensity rank 295 1144 1648 2373 ance:±15%	(to be 1 ·31) e luminou per one ou e dimensio oth : 225n (Note 1) inous inte ~ ~ ~	s intensity ra uter package on nm, Hight : <u>nsity</u> <u>1548</u> 2229 <u>3210</u> (4623)	90mm Unit mcd	(Ta=25°C) Condition I_F =20mA	niesponding (o / s)	
 S Date of pro 6-1-2. Outer pa Put 8 pa (approxi 6-1-3. Outer pa Width : 6-2.Luminous i Rank M N O P (Note 1) Tolera In reg. 	production oduction(01~ ackage acks (the same imately 670g p ackage out line 140mm, Dep intensity rank 140mm, Dep intensity rank 295 1144 1648 2373 ance:±15% ard to luminou	(to be 1 \cdot 31) e luminou per one ou e dimensio oth : 225r (Note 1) inous inte ~ ~ us intensio	s intensity ra uter package on nm, Hight : <u>1548</u> <u>2229</u> <u>3210</u> (4623) ty, the follow	90mm Unit wing ranking	(Ta=25°C) (Ta=25°C) Condition I_F =20mA shall be carrie	ed out.	
 S Date of pro 6-1-2. Outer pa Put 8 pa (approxi) 6-1-3. Outer pa Width : 6-2.Luminous i Rank M O P (Note 1) Tolera In reganet 	production oduction(01~ ackage acks (the same imately 670g p ackage out line 140mm, Dep intensity rank 140mm, Dep intensity rank 2373 ance:±15% ard to luminouver the quantit	(to be 1 *31) e luminou per one ou e dimensio oth : 225n (Note 1) inous inte ~ ~ us intension ty of each	s intensity ra uter package on nm, Hight : <u>1548</u> <u>2229</u> <u>3210</u> (4623) ty, the follow rank shall no	90mm Unit mcd wing ranking ot be pre scri	(Ta=25°C) (Ta=25°C) Condition I_F =20mA shall be carrie bed.	ed out.	
 S Date of pro 6-1-2. Outer pa Put 8 pa (approxi 6-1-3. Outer pa Width : 6-2. Luminous i Rank M O P (Note 1) Tolera In reg. Howev In case 	production oduction(01~ ackage acks (the same imately 670g p ackage out line 140mm, Dep intensity rank 795 1144 1648 2373 ance:±15% ard to luminou ver the quantit e of the distrib	(to be 1 ·31) e luminou per one ou e dimensio oth : 225r (Note 1) inous inte ~ ~ us intensit ty of each oution of the	s intensity ra uter package on nm, Hight : <u>nsity</u> <u>1548</u> <u>2229</u> <u>3210</u> (4623) ty , the follow rank shall no he luminous	90mm Unit mcd wing ranking ot be pre scri intensity shift	(Ta=25°C) Condition I_F =20mA shall be carrie bed. ft to high, at the	ed out.	
 S Date of pro 6-1-2. Outer pa Put 8 pa (approxi 6-1-3. Outer pa Width : 6-2.Luminous i 6-2.Luminous i Rank M N O P (Note 1) Tolera In regander Howev In case point m 	production oduction(01~ ackage acks (the same imately 670g p ackage out line 140mm, Dep intensity rank 795 1144 1648 2373 ance:±15% ard to luminou ver the quantit e of the distrib	(to be 1 ·31) e luminou per one ou e dimensio oth : 225r (Note 1) inous inte ~ ~ us intensit ty of each bution of th k is prescri	s intensity ra uter package on nm, Hight : <u>1548</u> <u>2229</u> <u>3210</u> (4623) ty , the follow rank shall no he luminous ribed and low	90mm Unit mcd wing ranking ot be pre scri intensity shift wer rank is de	(Ta=25°C) (Ta=25°C) Condition I_F =20mA shall be carried bed. ft to high, at the elete.	ed out.	
 S Date of pro 6-1-2. Outer pa Put 8 pa (approxi 6-1-3. Outer pa Width : 6-2.Luminous i 6-2.Luminous i Rank M O P (Note 1) Tolera In reg Howev In case point n 	production oduction(01~ ackage acks (the same imately 670g p ackage out line 140mm, Dep intensity rank 140mm, Dep intensity rank 2373 ance:±15% ard to luminouver the quantit e of the distributer of the d	(to be 1 ·31) e luminou per one ou e dimensio oth : 225n (Note 1) inous inte ~ ~ us intension ty of each oution of th k is presco	s intensity ra uter package on nm, Hight : <u>1548</u> <u>2229</u> <u>3210</u> (4623) ty, the follow rank shall no he luminous ribed and low	90mm 90mm wing ranking ot be pre scri intensity shift wer rank is de	(Ta=25°C) (Ta=25°C) Condition $I_F=20mA$ shall be carrie bed. ft to high, at the elete.	ed out.	
 S Date of pro 6-1-2. Outer pa Put 8 pa (approxi 6-1-3. Outer pa Width : 6-2. Luminous i 6-2. Luminous i Rank M O P (Note 1) Tolera In reganse Howev In case point m 	production oduction(01~ ackage acks (the same imately 670g p ackage out line 140mm, Dep intensity rank 795 1144 1648 2373 ance:±15% ard to luminou ver the quantit e of the distrib new upper rank	(to be 1 ·31) e luminou per one ou e dimensio oth : 225r (Note 1) inous inte ~ ~ ~ us intensit ty of each pution of the k is prescri-	s intensity ra uter package on nm, Hight : <u>nsity</u> <u>1548</u> <u>2229</u> <u>3210</u> (4623) ty, the follow rank shall no he luminous ribed and low 2)	90mm Unit mcd wing ranking ot be pre scri intensity shift wer rank is de	(Ta=25°C) Condition I_F =20mA shall be carrie bed. ft to high, at the elete. (Ta=25°C)	ed out.	
 S Date of pro 6-1-2. Outer pa Put 8 pa (approxi 6-1-3. Outer pa Width : 6-2.Luminous i 6-2.Luminous i 6-2.Luminous i Rank M N O P (Note 1) Tolera In reganse However In case point m 6-3.Dominant w Rank 	production oduction(01~ ackage acks (the same imately 670g p ackage out line 140mm, Dep intensity rank 795 1144 1648 2373 ance:±15% ard to luminouver the quantite of the distrib new upper rank wavelength ran Domin	(to be 1 ·31) e luminou per one ou e dimensio oth : 225r (Note 1) inous inte ~ ~ us intensit ty of each oution of th k is prescu	s intensity ra uter package on nm, Hight : <u>1548</u> 2229 3210 (4623) ty , the follow rank shall no he luminous ribed and low 2)	90mm Unit mcd wing ranking ot be pre scri intensity shift wer rank is de	(Ta=25°C) Condition I_F =20mA shall be carrie bed. ft to high, at the elete. (Ta=25°C) Condition	ed out.	
 S Date of pro 6-1-2. Outer pa Put 8 pa (approxi 6-1-3. Outer pa Width : 6-2.Luminous i 6-2.Luminous i Rank M O P (Note 1) Tolera In reg. Howev In case point n 6-3.Dominant w Rank H 	production oduction(01 \sim ackage imately 670g p ackage out line 140mm, Dep intensity rank 140mm, Dep intensity rank 140mm, Dep intensity rank 140mm, Dep intensity rank 2373 ance: $\pm 15\%$ ard to luminor ver the quantit e of the distrib new upper rank wavelength ran Domin 581.0	(to be 1 *31) e luminou per one ou e dimensio oth : 225n (Note 1) inous inte ~ ~ us intensit ty of each hution of ti k is prescu nk (Note 2 vant wavel ~	s intensity ra uter package on nm, Hight : <u>1548</u> 2229 3210 (4623) ty, the follow rank shall nu he luminous ribed and low 2) length 584.5	90mm 90mm wing ranking ot be pre scri intensity shift wer rank is de	(Ta=25°C) (Ta=25°C) Condition I_F =20mA is shall be carrie bed. ft to high, at the elete. (Ta=25°C) Condition	ed out.	
 S Date of pro G Date of pro G Date of pro G Date of pro G Put 8 pa (approxi G Date of pro G Put 8 pa (approxi G Date of pro G Put 8 pa (approxi G Date of pro G Date of pro<td>production oduction(01~ ackage acks (the same imately 670g p ackage out line 140mm, Dep intensity rank 795 1144 1648 2373 ance:±15% ard to luminouver the quantit e of the distrib new upper rank wavelength ran Domin 581.0 583.5</td><td>(to be 1 ·31) e luminou per one ou e dimensio oth : 225r (Note 1) inous inte ~ ~ us intensit ty of each oution of the k is prescr nk (Note 2) ~ ~ ~</td><td>s intensity ra uter package on nm, Hight : <u>1548</u> 2229 <u>3210</u> (4623) ty, the follow rank shall no he luminous ribed and low 2) length 584.5 587.0</td><td>90mm 90mm unit mcd wing ranking ot be pre scri intensity shift wer rank is de</td><td>(Ta=25°C) Condition I_F=20mA shall be carrie bed. ft to high, at the elete. (Ta=25°C) Condition</td><td>ed out.</td><td></td>	production oduction(01~ ackage acks (the same imately 670g p ackage out line 140mm, Dep intensity rank 795 1144 1648 2373 ance:±15% ard to luminouver the quantit e of the distrib new upper rank wavelength ran Domin 581.0 583.5	(to be 1 ·31) e luminou per one ou e dimensio oth : 225r (Note 1) inous inte ~ ~ us intensit ty of each oution of the k is prescr nk (Note 2) ~ ~ ~	s intensity ra uter package on nm, Hight : <u>1548</u> 2229 <u>3210</u> (4623) ty, the follow rank shall no he luminous ribed and low 2) length 584.5 587.0	90mm 90mm unit mcd wing ranking ot be pre scri intensity shift wer rank is de	(Ta=25°C) Condition I_F =20mA shall be carrie bed. ft to high, at the elete. (Ta=25°C) Condition	ed out.	
 S Date of pro 6-1-2. Outer pa Put 8 pa (approxi 6-1-3. Outer pa Width : 6-2.Luminous i 6-2.Luminous i Rank M O P (Note 1) Tolera In reganse However In case point m 6-3.Dominant w Rank H I J 	production oduction(01 \sim ackage imately 670g p ackage out line 140mm, Dep intensity rank 140mm, Dep intensity rank 2373 ance: $\pm 15\%$ ard to luminouver the quantite of the distribution wavelength ran 581.0 583.5 586.0	(to be 1 ·31) e luminou per one ou e dimensio oth : 225r (Note 1) inous inte ~ ~ us intensit ty of each bution of th k is prescr ant wavel ~ ~	s intensity ra uter package on nm, Hight : 1548 2229 3210 (4623) ty , the follow rank shall nu- he luminous ribed and low 2) length 584.5 587.0 589.5	ank) into oute) 90mm Unit mcd wing ranking ot be pre scri intensity shi wer rank is de Unit	(Ta=25°C) (Ta=25°C) Condition $I_F=20mA$ shall be carrie bed. ft to high, at the elete. (Ta=25°C) Condition $I_F=20mA$	ed out.	
 S Date of pro 6-1-2. Outer pa Put 8 pa (approxi 6-1-3. Outer pa Width : 6-2.Luminous i 6-2.Luminous i 6-2.Luminous i Rank M O P (Note 1) Tolera In reg: Howev In case point m 6-3.Dominant w Rank H I J K 	production oduction(01 \sim ackage imately 670g p ackage out line 140mm, Dep intensity rank 140mm, Dep intensity rank 140mm, Dep intensity rank 140mm, Dep intensity rank 2373 ance: $\pm 15\%$ ard to luminor ver the quantite of the distrib new upper rank wavelength ran Domin 581.0 583.5 586.0 588.5	(to be 1 \cdot 31) e luminou per one ou e dimensio oth : 225m (Note 1) inous inte \sim \sim us intensit ty of each bution of the k is prescu- inant wavel \sim \sim \sim \sim \sim \sim \sim \sim	s intensity ra uter package on nm, Hight : 1548 2229 3210 (4623) ty, the follow rank shall nu- he luminous ribed and low 2) length 584.5 587.0 589.5 592.0	90mm 90mm unit mcd wing ranking ot be pre scri intensity shift wer rank is de Unit nm	(Ta=25°C) (Ta=25°C) Condition I_F =20mA is shall be carried bed. ft to high, at the elete. (Ta=25°C) Condition I_F =20mA	ed out. at	

This rank value is the setting value of when that classifies it the rank and be not a guarantee value. Also I shall not ask the delivery ratio of each rank.

	DG996040	Jun/16/99
	MODEL No.	PAGE
	GL5ZV44	8/10
86		

6-4. Environment

6-4-1. Ozonosphere destructive chemicals.

- (1) The device doesn't contain following substance.
- (2) The device doesn't have a production line whose process requires following substance. Restricted part: CFCs,halones,CCl₄,Trichloroethane(Methychloroform)

6-4-2. Bromic non-burning materials

The device doesn't contain bromic non-burning materials(PBBOs,PBBs)

DG996040	Jun/16/99
MODEL No.	PAGE
GL577V44	9/10

7. Precautions for use

7-1. Lead forming method

Avoid forming a lead pin with the lead pin base as a fulcrum: be sure to hold a lead pin firmly when forming. Lead pins should be formed before soldering.

- 7-2. Notice of installation
 - 7-2-1 installation on a PWB
 - When mounting an LED lamp on a PWB, do not apply physical stress to the lead pins.
 - The lead pin pitch should match the PWB pin-hole pitch: absolutely avoid widening or narrowing the lead pins.
 - When positioning an LED lamp, basically employ an LED with tie-bar cut or use a spacer.
 - 7-2-2 When an LED 1 is mounted directly on a PWB If the bottom face of an LED lamp is mounted directly on single-sided PWB, the base of the lead pins may be subjected to physical stress due to PWB warp, cutting or clinching of lead pins. Prior to use, be sure to check that no disconnection inside of the resin or damage to resin etc., is found. When an LED lamp is mounted on a double-sided PWB, the heat during soldering affects the resin; therefore, keep the LED lamp more that 1.6mm afloat above the PWB.
 - 7-2-3 Installation using a holder During an LED lamp positioning, when a holder is used, a holder should be designed not to subject lead pins to any undue stress.
 - (Note)Pay attention to the thermal expansion coefficient of the material used for the holder. Since the holder expands and contracts due to preheat and soldering heat, mechanical stress may be applied to the lead pins, resulting in disconnection.

7-2-4 Installation to the case

Do not fix part C with adhesives when fixed to the case as shown in Figure A hole of the case should be designed not to subject the inside of resin to any undue stress.









DG996040	Jun/16/99
MODEL No.	PAGE
GL5ZV44	10/10

7-3. Soldering Conditions

Solder the lead pins under the following conditions

Type of Soldering	Conditions	
1. Manual soldering	295°C±5°C, within 3 seconds	
2. Wave soldering	260℃±5℃, within 5 seconds	
3. Auto soldering	Preheating 70°C to 80°C, within 30 seconds	
	Soldering 245°C±5°C, within 5 seconds	

(Note) Avoid dipping resin into soldering bath.

Avoid applying stress to lead pins while they are heated. For example, when the LED lamp is moved with the heat applied to the lead pins during manual soldering or solder repair, disconnection may occur.



7-4. For cleaning

- (1) Solvent cleaning: Solvent temperature 45°C or less Immersion for 3 min or less
- (2) Ultrasonic cleaning: The effect to device by ultrasonic cleaning differs by cleaning bath size, ultrasonic power output, cleaning time, PWB size or device mounting condition etc. Please test it in actual using condition and confirm that doesn't occur any defect before starting the ultrasonic cleaning.
- (3) Applicable solvent: Ethyl alcohol, Methyl alcohol, Isopropyl alcohol

In case when the other solvent is used, there are cases that the packaging resin is eroded. Please use the other solvent after thorough confirmation is performed in actual using condition.